

metal-oxide-silicon-on-insulator 구조에서 고정 산화막 전하가 미치는 영향

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Effect of the fixed oxide charge on the metal-oxide-silicon-on-insulator structures

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Abstract : Metal-oxide-silicon-on-insulator (MOSOI) structures were fabricated to study the effect caused by reactive ion etching (RIE) and sacrificial oxidation process on silicon-on-insulator (SOI) layer. The MOSOI capacitors with an etch-damaged SOI layer were characterized by capacitance-voltage ($C-V$) measurements and compared to the sacrificial oxidation treated samples and the reference samples without etching treatment. The measured $C-V$ curves were compared to the numerical results from 2-dimensional (2-D) simulations. The measurements revealed that the profile of $C-V$ curves significantly changes depending on the SOI surface condition of the MOSOI capacitors. The shift in the measured $C-V$ curves, due to the difference of the fixed oxide charge (Q_f), together with the numerical simulation analysis and atomic force microscopy (AFM) analysis, allowed extracting the fixed oxide charges (Q_f) in the structures as well as 2-D carrier distribution profiles.

Key Words : etch damage, interface states, $C-V$, Silvaco Atals, AFM